International Semiconductor Device Research Symposium December 12-14, 2007 Stamp Student Union University of Maryland College Park, Maryland, USA

Technical Program

Wednesday, December 12, 2007

WP1: Novel Device Structures - 1:30pm - 3:30pm

Chairperson: Dr. Agis Iliadis, University of Maryland Meeting Room: Colony Ballroom

1:30pm - 1:50pm	WP1-01 Student Strained Si n-FET featuring compliant SiGe Stress Transfer Layer (STL) and Si0.98C0.02 Source/Drain Stressors for Performance Enhancement
	Grace Huiqi Wang, Eng- Huat Toh, Ganesh Samudra, and Yee-Chia Yeo, National University of Singapore, Doran Weeks, Trevan Landin, Jennifer Spear, and Shawn G. Thomas, ASM, and Chih Hang Tung, Institute of Microelectronics
1:50pm - 2:10pm	WP1-02 Student Superior n-MOSFET Performance by Optimal Stress Design Ying-Jhe Yang, M. H. Liao, and C. W. Liu, National Taiwan University, and Lingyen Yeh, TL. Lee, and MS. Liang, Taiwan Semiconductor Manufacturing Company
2:10pm - 2:30pm	WP1-03 Student Temperature Dependent Transport Characteristics of Multi-Bridge-Channel MOSFETs (MBCFETs) YoungChai Jung, ByoungHak Hong, SuHeon Hong, and SungWoo Hwang, Korea Univeristy, D. Ahn, University of Seoul, and KeunHwi Cho, Sung-Young Leem, Min-Sang Kim, Eun-Jung Yoon, Dong-Won Kim, and Donggun Park, Samsung Electronics Co.
2:30pm - 2:50pm	WP1-04 Student New Bi-Directional T-Shaped Triple Gate n-type Poly-Si TFT by a Low-Temperature SLS-Process for Reducing Kink Effects Sung-Hwan Choi, Hee-Sun Shin, and Min-Koo Han, Seoul National University
2:50pm - 3:10pm	WP1-05 Student InAs Growth On Submicron (100) SOI Islands for InAs-Si Composite Channel MOSFETs Bin Wu and Dana Wheeler, University of Notre Dame, Changhyun Yi, Inho Yoon, and April Brown, Duke University, Smita Jha and Thomas Kuech, University of Wisconsin-Madison, and Patrick Fay and Alan Seabaugh, University of Notre Dame
3:10pm - 3:30pm	WP1-06 Student Self-aligned Inversion N-channel In0.2Ga0.8As/GaAs MOSFET with TiN Gate and Ga2O3(Gd2O3) Dielectric Chih-Ping Chen, Tsung-Da Lin, Yao-Chung Chang, Mingwhei Hong, and J. Raynien Kwo, National Tsing Hua University

WP2: Space Application and Extreme Environments I - 1:30pm - 3:30pm

Chairperson: Dr. Robert Walters, NRL Co-chairperson: Dr. Shahid Aslam, NASA Meeting Room: Margaret Brent Room

1:30pm - 2:05pm	WP2-01 Invited Using SiGe Technology in Extreme Environments John D. Cressler, Georgia Tech
2:05pm - 2:25pm	WP2-02 Addressing Challenges in Device-Circuit Modeling for Extreme Environments of Space Ashok Raman, Marek Turowski, and Alex Fedoseyev, CFD Research Corporation (CFDRC), and John D. Cressler, Georgia Institute of Technology
2:25pm - 2:45pm	WP2-03 Effects of Cryogenic Temperatures on Small-Signal MOSFET Capacitances Akin Akturk and Neil Goldsman, University of Maryland
2:45pm - 3:05pm	WP2-04 Controlled Localized Heating on Integrated Circuits for Cold-Ambient Temperature Applications Zeynep Dilli, Akin Akturk, and Neil Goldsman, University of Maryland
3:05pm - 3:25pm	WP2-05 SiGe HBT Compact Modeling in Extreme Temperatures Beth O. Woods, and H. Alan Mantooth, University of Arkansas, and John D. Cressler, Georgia Institute of Technology

WP3: Oxides and Dielectrics I - 1:30pm - 3:30pm

Chairperson: Dr. John Williams, Auburn University Meeting Room: Juan Jimenez Room

1:30pm - 1:50pm	WP3-01 Quantum Mechanical Study of Gate Leakage Current in Double Gate MOS Structures Sabbir Ahmed, Md. Kawsar Alam, Ahsan - Ul - Alam, Md. Golam Rabbani, and Quazi Deen Mohd. Khosru, Bangladesh University of Engineering and Technology
1:50pm - 2:10pm	WP3-02 Student Organic Field-effect Transistor Channel Perturbation at Two Surfaces through Analyte Binding and Dielectric Charging C.H. Fu, H.C. Chuang, and T.K. Wang, National Tsing Hua University, and S.F. Huang, W.F. Tsai, and C.F. Ai, Institution of Nuclear Energy Research
2:10pm - 2:30pm	WP3-03 Large Leakage Current Reduction of Silicon Oxide and High-K Oxides Using the Phonon-Energy-Coupling Enhancement Effect Zhi Chen, Pangleen Ong, and Chandan B. Samantaray, University of Kentucky
2:30pm - 2:50pm	WP3-04
	Iransport in Metal-Molecule-Silicon Devices Adina Scott and David Janes, Purdue University
2:50pm - 3:10pm	Iransport in Metal-Molecule-Silicon Devices Adina Scott and David Janes, Purdue University WP3-05 Student InGaAs n-MOS Devices Integrated using ALD-HfO2/metal Gate Without Surface Cleaning and Interfacial Layer Passivation V Clear Clear Net in LT in U. U. in the second secon
2:50pm - 3:10pm	Iransport in Metal-Molecule-Silicon Devices Adina Scott and David Janes, Purdue University WP3-05 Student InGaAs n-MOS Devices Integrated using ALD-HfO2/metal Gate Without Surface Cleaning and Interfacial Layer Passivation Yao-Chung Chang, National Tsing Hua University

WP4: Sensors and Biosensors - 1:30pm - 3:30pm

Chairperson: Dr. David Janes, Purdue Co-chairperson: Dr. Nicholas Fell, ARL Meeting Room: Charles Carroll Room

1:30pm - 1:50pm	WP4-01 Student Integrated Solid-State Optoelectronic Sensor System for Biochemical Detection and Quantification Clement Joseph and David Starikov, University of Houston, Hanae Naoum and Mounir Boukadoum, University of Quebec at Montreal, and Abdelhak Bensaoula, Center for Advanced Materials, University of Houston
1:50pm - 2:10pm	WP4-02 Student Numerical Modeling of Nanotube Embedded Chemicapacitive Sensors Tal Rusak, Cornell University, and Akin Akturk and Neil Goldsman, University of Maryland
2:10pm - 2:30pm	WP4-03 Student Barrier Height Modulation and Dipole Moments in Metal-Molecule-Silicon Diodes Adina Scott and David B. Janes, Purdue University, and Chad Risko, Mark A. Ratner, Northwestern University
2:30pm - 2:50pm	WP4-04 Student Au/ZnO-Nanocomposite/(100)Si N-P Heterojunction Diodes For Gas Sensors Hasina Ali and Agis Iliadis, University of Maryland
2:50pm - 3:10pm	WP4-05 Student Effects of Oxygen Content on the Structural and Sensing Properties of Y2O3 Sensing Membrane for pH-ISFET Application Tung-Ming Pan, Kao-Ming Liao, Li-Chen Yen, Yu-Yi Hsieh, and Yue-Zhang Chen, Chang Gung University
3:10pm - 3:30pm	WP4-06 Sensing Characteristics of a Novel MISiC Schottky-Diode Hydrogen Sensor with HfO2 as Gate Insulator W.M. Tang, C.H. Leung, and P.T. Lai, The University of Hong Kong
WP5: Novel Chairperson: 1 Meeting Room:	Devices II - 3:45pm - 5:45pm Dr. Akin Akturk, University of Maryland Colony Ballroom
3:45pm - 4:05pm	WP5-01 Simulation of Silicon Nanowire Tunneling Field-Effect Transistors Including Quantum Effects Alexander Heigl and Gerhard Wachutka, TU München
4:05pm - 4:25pm	WP5-02 Student Silicon Nano-Wire Impact Ionization Transistors with Multiple-Gates For Enhanced Gate Control and Performance Eng-Huat Toh, Grace Huiqi Wang, Chen Shen, Ming Zhu, Lap Chan, Chun-Huat Heng, Ganesh Samudra, and Yee-Chia Yeo, National University of Singapore (NUS)
4:25pm - 4:45pm	WP5-03 Device and Circuit Modeling using Novel 3-State Quantum Dot Gate FETs Faquir Jain, Supriya Karmakar, and Dr. John Chandy, University of Connecticut, and Dr. Evan Heller, RSoft Design Group
4:45pm - 5:05pm	WP5-04 Student Poly-silicon Quantum Dot Single Electron Transistors Kwon-Chil Kang, Hong Sun Yang, Byung-Gook Park, and Jong Duk Lee, Seoul National University, Sangwoo Kang, Hynix, and Seung-hwan Song and Jinho Kim, Samsung Electronics
5:05pm - 5:25pm	WP5-05 Student A Quantum Dot Memory Cell Based on Spin Polaron Formation Hani Enaya, Yuriy G. Semenov, and Ki Wook Kim, North Carolina State University, and John M. Zavada, U.S. Research Amry Office
5:25pm - 5:45pm	WP5-06 Student A Novel Capacitor-less 2-T SOI DRAM Cell

WP6: Space Applications and Extreme Environments II - 3:45pm - 5:45pm

Chairperson: Dr. John Cressler, Georgia Tech Co-Chairperson: Dr. Andrew Keys, NASA Meeting Room: Margaret Brent Room

3:45pm - 4:10pm	WP6-01 Student A Comparison of 63 MeV Proton and 10 keV X-ray Radiation Effects in 4H-SiC Enhancement-Mode Vertical Trench JFETs Stan Phillips, Bongim Jun, Akil Sutton, and John D Cressler, Georgia Institute of Technology, Neil Merrett, Semisouth, Paul W. Marshall, NASA Consultant, and John Williams, Auburn University
4:10pm - 4:35pm	WP6-02 Advanced Rad Hard SRAM Development and Hardware Test Results Scott Doyle, BAE Systems
4:35pm - 5:00pm	WP6-03 Student Hydrogen-terminated Boron-doped Diamond Films under Intense Gamma Irradiation Sanju Gupta, M. Muralikiran, J. Farmer, and C. M. Greenlief, UMC, J. D. Robertson, J. Farmer, UMC & MURR, and X. Han, Brewer Sciences Inc.
5:00pm - 5:25pm	WP6-04 Student Proton Induced SEU in SiGe Digital Logic at Cryogenic Temperatures Akil K. Sutton and John D. Cressler, Georgia Institute of Technology, Martin A. Carts, Muniz Engineering, Paul W. Marshall, Consultant to NASA-GSFC, Jonathan A. Pellish, Robert A. Reed, and Michael L. Alles, Vanderbilt University, and Guofu Niu, Auburn University
5:25pm - 5:45pm	WP6-05 Student High Resistivity Material for Mitigating Linear Energy Transfer Sensitivities in Highly Scaled Cmos Sram Cells Esau Kanyogoro and Harold Hughes, Naval Research Laboratory, Martin Peckerar, University of Maryland, and Mike Liu, Honeywell Aerospace
WP7: Oxides a Chairperson: D Meeting Room:	and Dielectrics II - 3:45pm - 5:45pm r. Patricia Mooney, Simon Fraser University Juan Jimenez Room
3:45pm - 4:05pm	WP7-01 Student Thermal and Humidity Stability of Ge3N4 Thin Layers Fabricated by High-Density Plasma Nitridation Katsuhiro Kutsuki, Gaku Okamoto, Takuji Hosoi, Akitaka Yoshigoe, Yuden Teraoka, Takayoshi Shimura, and Heiji Watanabe, Osaka University
4:05pm - 4:35pm	WP7-02 Invited Electron Capture and Emission at Interface States in As-Oxidized and NO-Annealed SiO2/4H-SiC Patricia M. Mooney and Xudong Chen, Simon Fraser University, Sarit Dhar, Vanderbilt University, Leonard C. Feldman, Vanderbilt University and Rutgers University, and John R. Williams and Tamara Isaacs-Smith, Auburn University
4:35pm - 4:55pm	WP7-03 Student Impact of Nitridation on Negative and Positive Charge Buildup in SiC Gate Oxides John Rozen, Sarit Dhar, and Leonard C. Feldman, Vanderbilt University, and John R. Williams, Auburn University
4:55pm - 5:15pm	WP7-04 Student A High-k Y2TiO5 Charge Trapping Layer for High-Density Flash Memory Application Tung-Ming Pan, Wen-Wei Yeh, Wei-Tsung Chang, Kai-Ming Chen, Jing-Wei Chen, and Kuo-Chan Huang, Chang Gung University
5:15pm - 5:35pm	WP7-05 Student Novel SONOS-Type Nonvolatile Memory Device with Stacked Tunneling and Charge-Trapping Layers Kuei-Shu Chang-Liao, Ping-Hung Tsai, Tai-Yu Wu, and Tien-Ko Wang, National Tsing Hua University, and Pei-Jer Tzeng, Cha-Hsin Lin, Lung-Sheng Lee, and Ming-Jin Tsai, Industrial Technology Research Institute

WP8: Modeling Gate Related Effects - 3:45pm - 5:45pm

Chairperson: Dr. Eric Pop, University of Illinois Meeting Room: Charles Carroll Room

3:45pm - 4:05pm	WP8-01 Student Effects of Gate-Edge Metamorphosed(GEM) on Device Characteristics of Scaled MOSFETs Tatsuya Yamada and Nobuyuki Sano, University of Tsukuba
4:05pm - 4:25pm	WP8-02 Student A Quantum Mechanical Model of Gate Leakage Current for Scaled NMOS Transistors with Ultra-thin High-K Dielectrics and Metal Gate Electrodes Yanli Zhang, Zhian Jin, Gan Wang, Luckshitha S. Liyanage, and Marvin H. White, Lehigh University
4:25pm - 4:55pm	WP8-03 Student Impact of Local Poly-Si Gate Depletion on Vth Variation in Nanoscale MOSFETs Investigated by 3D Device Simulation Arifin Tamsir Putra, University of Tokyo, Akio Nishida, Shiro Kamohara, and Takaaki Tsunomura, MIRAI-Selete, and Toshiro Hiramoto, IIS, University of Tokyo & MIRAI-Selete
4:55pm - 5:15pm	WP8-04 Student Write/Erase Speed Modeling of Scaled SONOS and TANOS Gan Wang, Nathan Eichenlaub, Zhian Jin, Yanli Zhang, and Marvin H. White, Lehigh University
5:15pm - 5:35pm	WP8-05 Student Investigation of a MOSCAP Using NEG Markus Karner, Oskar Baumgartner, Madhi Pourfath, Martin Vasicek, and Hans Kosina, Institute for Microelectronics

WP9: Poster Session - 6pm - 8:30pm

Chairperson: Dr. Neil Goldsman, University of Maryland Meeting Room: Grand Ballroom

WP9-01 - Novel Device Concepts and Ideas

WP9-01-01 Student

Re-configurable All-Optical Devices Based on Electrically Controlled Cross-Polarized Wave Conversion Montasir Qasymeh and Michael Cada, Dalhousie University and Dr.Jaromir Pistora, VSB-TU Ostrava

WP9-01-02 Student

Single Poly EEPROM with N-well and Stacked MIM Capacitor for Control Gate Zhi-Yuan Cui, Guk-Hwan Kim, Hong-Sik Kim, Hyung-Gyoo Lee, Nam-Soo Kim, Byeong-Seong So, and In-Seok Jung, Chungbuk National University

WP9-01-03 Student

On-State and Switching Performance Investigation of Sub-50nm L-DUMGAC MOSFET Design for High-Speed Logic Applications Rishu Chaujar, Ravneet Kaur, Mridula Gupta, and R.S. Gupta, UDSC, and Manoj Saxena, University of Delhi

WP9-01-04 Student

Impact of Laterally Asymmetric Channel and Gate Stack Architecture on Device Performance of Surrounding Gate MOSFET: A Simulation Study

Harsupreet Kaur, Sneha Kabra, and R. S. Gupta, Semiconductor Devices Research Laboratory, and Subhasis Haldar, University of Delhi

WP9-01-05 Student

Enhanced Performance in Strained n-FET with Double-Recessed Si:C Source/Drain and Lattice-Mismatched SiGe Strain-Transfer Structure (STS)

Kah-Wee Ang, Hoong-Shing Wong, Ganesh Samudra, and Yee-Chia Yeo, National University of Singapore, and N. Balasubramanian, Institute of Microelectronics, Singapore

WP9-01-06 Student

Negative Read Biasing Effects for the Reliable Operation of NOR Type Floating Gate Flash Memory Devices Seongjae Cho, Il Han Park, Jong Duk Lee, and Byung-Gook Park, Seoul National University

WP9-01-07

Fin Width Variation Effects of Program Disturbance Characteristics on NAND Type Bulk Fin SONOS Flash Memory II Hwan Cho, II Han Park, Hyungcheol Shin, Byung-Gook Park, and Jong Duk Lee, Seoul National University and Jong-Ho Lee, Kyungpook National University

WP9-01-08 Student

Fin and Recess Channel MOSFET (FiReFET) for Performance Enhancement of Sub-50 nm DRAM Cell Jae Young Song, Jong Pil Kim, Sang Wan Kim, Han Ki Jung, Jae Hyun Park, Jong Duk Lee, and Byung-Gook Park, Seoul National University

WP9-01-09 Student

New EEPROM Concept for Single Bit Operation

V. Bidal, A. Regnier, and J.M. Mirabel, ST Microelectronics, R. Laffont and R. Bouchakour, L2MP, and J.R. Raguet, L2MP and ST Microelectronics

WP9-01-10 Student

Optimum Design of Spacer-type Storage Nodes in Recessed Channel Structure for 2-bit/cell SONOS Flash Memory Cell Jong-Ho Lee, Kyoung-Rok Han, H. Jung, K.-H. Park, Y. M. Kim, B.-K. Choi, and S.-G. Jung, Kyungpook National University

WP9-01-11 Student

FinFETs with Both Large Body Factor and High Drive-Current Keisuke Takahashi, Arifin Tamsir Putra, Ken Shimizu, and Toshiro Hiramoto, University of Tokyo

WP9-01-12 Student

A Novel SiGe-On-Insulator IMOS Device with Reduced Bias Voltages Hamed Nematian and Morteza Fathipour, University of Tehran, Hassan S. Hajghasem, Research Inistitute in Ministry of ICT, and Farzan Farbiz, University of Illinois at Urbana Champaign

WP9-01-13 Student

Comparative Study of p+/n+ gate Modified Saddle MOSFET and p+/n+ gate Bulk FinFETs for Sub-50 nm DRAM Cell Transistors

Jong-Ho Lee, Ki-Heung Park, Kyoung Rok Han, Young Min Kim, and Byung-Kil Choi, Kyungpook National University

WP9-01-14 Student

Application of a Switch-type Comparator in 4-b FLASH ADC Zhi-Yuan Cui, Hong-Sik Kim, Hyung-Gyoo Lee, Nam-Soo Kim, Byeong-Seong So, and In-Seok Jung, Chungbuk National University

WP9-01-15 Student

Fin Flash Memory Cells with Separated Double Gates Jang-Gn Yun, Yoon Kim, Il Han Park, Seongjae Cho, Jung Hoon Lee, Doo-Hyun Kim, Gil Sung Lee, Dong Hua Lee, Se Hwan Park, Wonbo Shim Jong-Duk Lee, and Byung-Gook Park, Seoul National University

WP9-01-16 Student

High Capacitance Battery for Powering Distributed Networks Node Devices Yves Ngu, Zeynep Dilli, Martin Peckerar, and Neil Goldsman, University of Maryland

WP9-01-17

Engineered Surfaces of Multifunctional and Molecular Diamond for Biosensing Sanju Gupta, UMC

WP9-01-18 Student

Transistor with Moving Gate to Control Electron Flow Amey Churi, Parag Kurlawala, Leah Magaldi, and Sam Mil'shtein, UMass

WP9-01-19 Student

Rapid Melt Growth of Ge Tunnel Junctions for Interband Tunnel Transistors Qin Zhang, Surajit Sutar, Thomas Kosel, and Alan Seabaugh, University of Notre Dame

WP9-01-20 Student

Photodetector with Uniform Response in 620nm to 870nm Range Ameya Shendye, Anup Pillai and Sam Mil'shtein, UMass

WP9-01-21 Student

Alternative MOS Devices for the Manufacture of High-Density ICs Fabio Alessio Marino and Gaudenzio Meneghesso, University of Padova

WP9-02 - Modeling (Compact and Distributed)

WP9-02-01

Predicting the Reliability of Metal-Insulator-Metal Capacitors (MIMC) in Analog Devices by Modeling Jagdish Prasad and Bruce Greenwood, AMI Semiconductor

WP9-02-02

Development of Solid State Left-Handed Materials Using Intrinsic Quantum States Clifford M. Krowne, Naval Research Laboratory

WP9-02-03 Student*

A Quantum Mechanical Mobility Model for Scaled NMOS Transistors with Ultra-thin High-K Dielectrics and Metal Gate Electrodes

Yanli Zhang, Zhian Jin, Gan Wang, Luckshitha S. Liyanage, and Marvin H. White, Lehigh University

WP9-02-04 Student

A Compact Model for Fully Overlapped LDD FD SOI MOSFETs Guohe Zhang, Zhibiao Shao, and Kai Zhou, Xi'an Jiaotong University

WP9-02-05 Student

Drain Current Model for Undoped Symmetric Double-Gate FETs using a Velocity Saturation Model with Exponent n=2 Venkatnarayan Hariharan, Juzer Vasi, and V. Ramgopal Rao, IIT Bombay

WP9-02-06 Student

Analysis of the BSIMSOI Threshold Voltage Model for Short Channel PD-SOI DTMOS Abimael Jimenez-P., Javier De la Hidalga-W., Luis Hernández-M., and Pedro Rosales-Q., Instituto Nacional de Astrofísica Óptica y Electrónica (INAOE)

WP9-02-07

Wavefunction Penetration Effect on C-V Characteristic of Double Gate MOSFET Md. Kawsar Alam, Ahsan-Ul-Alam, Sabbir Ahmed, Md. Golam Rabbani, and Quazi Deen Mohd Khosru, Bangladesh University of Engineering and Technology

WP9-02-08

An Analytic, Compact Model of Threshold Voltage Variations for SONOS Memory Cells due to Lateral Migration Chun-Hsing Shih, Yuan Ze University, and Ji-Ting Liang, National Tsing Hua University

WP9-02-09 Student

An Alternate Approach of Modeling the Direct Tunneling (DT) Current through Multi-gate Stacks in High-K Devices Zhian Jin, Yanli Zhang, Gan Wang, and Marvin H. White, Lehigh University

WP9-02-10

Modeling Special High Frequency Devices Using Artificial Neural Networks Josef Dobes and Ladislav Pospisil, Czech Technical University in Prague

WP9-02-11 Student

A New Impact Ionization Current Model Applicable to Both Bulk and SOI MOSFETs by Considering Self-lattice-heating Chengqing Wei, Xing Zhou, and Guan Huei See, Nanyang Technological University

WP9-02-12

Physics-based Numerical Simulation for Design of High-Voltage, Extremely-High Current Density SiC Power Devices Leonardo M. Hillkirk and Allen R. Hefner, NIST, and Robert W. Dutton, Stanford University

WP9-02-13 Student

Redesign and Optimization of Semiconductor Devices Petru Andrei and Liviu Oniciuc, Florida State University

WP9-03 - MEMS

WP9-03-01 Student*

Thermopile Infrared Detector Fabricated with Dry Silicon Etchant XeF2 Hengzhao Yang, Chinese Academy of Sciences

WP9-03-02 Student

An Adaptive Nonlinear Estimator for the MEMS Capacitive Accelerometer Based on Adaptive Input-Output Feedback Linearization Faezeh Arab Hassani, Amir Farrokh Payam, and Morteza Fathipour, University of Tehran and Farzan Farbiz, University of Illinois at Urbana Champaign

WP9-03-03 Student

Effect of Squeeze-film Damping on the Dynamic Behavior of Circular and Rectangular Microplates S.ahmad Tajalli, M.T.Ahmadian, and Hamid Sadeghian, Sharif University of Technology

WP9-04 - Sensors and Biosensors

WP9-04-01

Fabrication of SnO2/CNTs Formaldehyde Gas Sensor Jing Wang, Song-Ying Cong, and Zhen-An Tang, Dalian University of Technology, and Bao-Fu Quan, Jilin University

WP9-04-02

Embedded Sensors for Mechanical Stress Monitoring in Copper Damascene Interconnects *R. Delamare, M. Kasbari, S. Blayac, and K. Inal, Centre de Microelectonique de Provence, and Ch. Rivero, STMicroelectronics*

WP9-04-03 Student

Functionalized Organic Semiconductor-based Field-effect Transistors for Phosphonate Vapor Detection Jai Huang, Joseph Miragliotta, Alan Becknell, and Howard E. Katz, The Johns Hopkins University

WP9-04-04 Student

Low Voltage Charge-Balanced Capacitance-Voltage Conversion Circuit for One-Side-Electrode-Type Fluid-Based Inclination Asrulnizam Bin Abd Manaf and Yoshinori Matsumoto, Keio University

WP9-04-05

Fluorescence Enhancement by Surface Gratings Christopher C. Davis, Yu-Ju Hung, Ehren Hwang, and Igor Smolyaninov, University of Maryland

WP9-04-06 Student

Nanostructured Substrates for SERS Detection of Serotonin to Indicate Heart Transplant Rejection Yu-Hsiang Cheng, Yoav Achiam, and Kristine Rosfjord, University of Maryland, and Chang Chang, Drexel University

WP9-04-07 Student

Towards a Smart Adaptive Feedback Circuit for Microsensors Reza Ghodssi, Xiao Zhu Fan, and Nathan Siwak, University of Maryland

WP9-05 - Oxides and Dielectrics

WP9-05-01 Student

Study of Low-Temperature and Post-Stress Hysteresis in High-k Gate Dielectrics Shi-Tin Lin, You-Lin Wu, Chang Cheng Yang, Chien-Hung Wu, and Albert Chin, National Chi Nan University

WP9-05-02 Student*

Temperature Dependant Characteristics of Scaled NMOS Transistors with Ultra-thin High-K Dielectrics and Metal Gate Electrodes

Yanli Zhang, Luckshitha S. Liyanage, Gan Wang, Zhian Jin, and Marvin H. White, Lehigh University

WP9-05-03

A Comparative Study Of Mos Memory Structures That Contain Platinum Or Gold Nanoparticles Sargentis Christos and Tsamakis Dimitris, National Technical University of Athens, and Travlos Anastasios and Giannakopoulos Kostas, National Centre for Scientific Research `Demokritos`

WP9-05-04 Student

The Effects of Plasma Treatment on the Thermal Stability of HfAlOx Thin Films Kow-Ming Chang, Bwo-Ning Chen, and Shih-Ming Huang, National Chiao-Tung University

WP9-05-05 Student

Modeling and Characterization of Soft Breakdown Phenomena in MOS Devices with Ultrathin High-k Gate Dielectric K M Farhan Shahil, Md. Nayeem Arafat, and Q. D. M. Khosru, Bangladesh University of Engineering and Technology(BUET), and M. Rezwan Khan, United International University

WP9-06 - Silicon on Insulator

WP9-06-01

Ballisticity at Very Low Drain Bias in DG SOI Nano-MOSFETs Carlos Sampedro, Francisco Gamiz, and Andrés Godoy, University of Granada, and Sorin Cristoloveanu, IMEP-INP Grenoble MINATEC

WP9-06-02 Student

The Role of the Temperature Boundary Conditions on the Gate Electrode on the Heat Distribution in 25 nm FD-SOI MOSFETs with SiO2 and Gate-stack Dragica Vasileska and Stephen M. Goodnick, Arizona State University, and Katerina Raleva, FEIT

WP9-06-03

The Role of the Temperature Boundary Conditions on the Gate Electrode on the Heat Distribution in 25 nm FD-SOI MOSFETs with SiO2 and Gate-stack Yongxun Liu, Takashi Matsukawa, Kazuhiko Endo, Meishoku Masahara, Shin-ichi O'uchi, Kunihiro Sakamoto, Kenichi Ishii, Junichi Tsukada, Yuki Ishikawa, Hiromi Yamauchi, and Eiichi Suzuki, AIST, and Atsushi Ogura and Tetsuro Hayashida, Meiji University

WP9-06-04 Student

STI Mechanical-StressvInduced Subthreshold Kink Effect of 40nm PD SOI NMOS Device James B Kuo, Ision Lin, and Vincen Su, National Taiwan University, and Cheng-Tzung Tsai and Chung-Sing Yeh, UMC

WP9-06-05

Non-isothermal Circuit for SOI MOSFETs for Electrothermal Simulation of SOI Integrated Circuits Ming-Cheng and Kun Zhang, Clarkson University

WP9-06-06 Student

Technological Constrains of Bulk FinFET Structure in Comparison with SOI FinFET Mirko Poljak and Tomislav Suligoj, University of Zagreb, and Vladimir Jovanovic, Delft University of Technology

WP9-07 - Organic Materials and Devices

WP9-07-01

An Enhanced Model for Circuit Simulation of Polymer Photodiodes and Solar Cells Michael Sams, University Linz, and Christoph Lackner and Timm Ostermann, JK-University

WP9-07-02 Student*

Design of an Organic TFT Pixel Electrode Circuit with Enhanced Current Programming Method for Active-Matrix OLED Displays

Aram Shin, Jong Chan Choi, and Man Young Sung, Korea University

WP9-07-03

Solution Process ZnO and Pentacene Bilayer Transistor: Ambipolar, p-channel and n-channel Operation Bhola N Pal and Howard E Katz, Johns Hopkins University

WP9-08 - Flexible Electronics

WP9-08-01 Student

The Operation of a-Si:H TFTs Flexible Electronics on Plastic Substrate M. H. Lee, Y.-T. Liu, C.-F. Huang, R.–S. Syu, and K.-W. Shen, National Taiwan Normal University, and K.-Y. Ho and P.-C. Chen, Industrial Technology Research Institute (DTC/ITRI)

WP9-08-02 Student*

Three-Dimensional Nano Electronics by Dielectrophoretic Assembly on a Flexible Substrate Chia-Ling Chen, Shih-Hsien Chao, Selvapraba Selvarasah, and Mehmet R. Dokmeci, Northeastern University

WP9-08-03

Chip-In-Flex Technology for Flexible Electronics Applications Jay Lewis and Dorota Temple, RTI International

WP9-08-04 Student

Deposition of Nanocrystalline Silicon Thin Film without Substrate Heating for Flexible Electronics Min-Koo Han, Joong-Hyun Park, Sun-Jae Kim, Sang-Myeon Han, and Seung-Hee Kuk, Seoul National University

WP9-08-05

Novel Method for Crystallization of Amorphous Silicon for Poly Silicon Liquid Crystal Displays Nick Doudoumopoulos and C. Paul Christensen, Potomac Photonics Inc.

WP9-08-06 Student

Vertical Integration using Transfer Printing Andrew Tunnell, Vince Ballarotto, and Ellen Williams. University of Maryland

WP9-09 - Engineering Education in Electronic Materials and Devices

WP9-09-01

Development of Learning Modules for Semiconductor and Device Courses Gregory Triplett and David Jonassen, University of Missouri-Columbia

WP9-09-02

Intehration of Physics/Chemistry into Teaching of Electronic Devices in Undergraduate Engineering Technology Programs Munir Sulaiman, Norfolk State University

WP9-09-03

Wire Drawing Tool for IC and MEMS CAD Optimized for Creating and Editing Wires on Multiples of 45 Degrees Roger Doering and Masahiro Nakagawa, California State University, East Bay, and Christopher Arnaiz, Kyocera

WP9-09-04

Relating Electrical and Computer Engineering to the High School Classroom Zeynep Dilli and Neil Goldsman, University of Maryland

WP9-09-05

K-12 Teachers Forum on Microelectronics and Nanotechnology Thomas Schulte, West Irondequoit High School, and Elaine Lewis, Michael Jackson, and Santosh Kurinec, Microelectronic Engineering

WP9-10 - Space/Extreme Environments

WP9-10-01 Student

Corner Lot Process Variation Effects on High Speed ADCs for Satellite Receivers Seokjin Kim and Martin M. Peckerar, University of Maryland, and Radmil Elkis, Hughes Network System,LLC

WP9-10-02

Dual Band Ultraviolet AlGaN Photodetectors for Space Applications Shahid Aslam, GSFC/NASA

WP9-10-03

Optimization of PIN Photodiodes Parameters for Enhanced Marcelo Cappelletti, Ariel Cédola, and Eitel Leopoldo Peltzer y Blancá, GEMYDE, UNLP

WP9-10-04

Numerical Simulations of Carrier Transport in Pillar Structured Solid State Thermal Neutron Detector Adam Conway, Rebecca Nikolic, and Tzu-Fang Wang, Lawrence Livermore National Lab

WP9-11 - Device Network Applications

WP9-11-01 Student

Improved RF Power Harvesting Circuit Design Thomas Salter, George Metze, and Neil Goldsman, University of Maryland

WP9-11-02 Student

A Physically designed 2.2 GHz OOK Receiver for Minimum Power Wireless Sensor Network Applications Bo Yang, Thomas S. Salter Jr., and Neil Goldsman, University of Maryland

WP9-11-03 Student

Design and Implementation of a Device Network Application for Distributed Line-crossing Recognition Chang-Ching Shen, Roni Kupershtok, Shuvra S. Bhattacharyya, and Neil Goldsman, University of Maryland

WP9-11-04 Student

Low Power Receiver Design Utilizing Weak Inversion and RF Energy Harvesting for Demodulation Thomas Salter, Bo Yang, and Neil Goldsman, University of Mayland

WP9-11-05 Student

Using Device Characteristics to Obtain a Low-Power Temperature-Insensitive Oscillator for Smart Dust Networks Yiming Zhai, Bo Yang, Thomas Salter, Neil Goldsman, and Pamela A. Abshire, University of Maryland

WP9-11-06

Integration of Small Antennas for Ultra Small Nodes in Wireless Sensor Networks Bo Yang, Xi Shao, Quirino Balzano, and Neil Goldsman, University of Maryland

WP9-12 - Advanced Characterization & Testing

WP9-12-01

Relative Intensity Noise Study in the Injection-locked Integrated Electroabsorption Modulator-Lasers Xaiomin Jin, California Polytechnic State University, and Bennet Yun Tarng and Shun Lien Chuang, University of Illinois at Urbana-Champaign

WP9-12-02 Student*

Analysis of the Mechanism and Characteristic for Energy Loss in a Gate-Commutated Thyristor Ru-Liang Zhang, Yong Gao, Xi Chen, and Cai-Lin Wang, Xi'an University of Technology

WP9-12-03 Student

Spatially Resolving the Degradation of SPC thin-film transistors Kai-Hsiang Chang, Ming-Hsien Lee, Horng-Chih Lin, and Tiao-Yuan Huang, National Chiao Tung University, and Yao-Jen Lee, National Nano Device Laboratories

WP9-12-04 Student

N+ Shallow Junction Formation using Plasma Doping and Rapid Thermal Annealing Seong Ho Kong, Jeong Eun Kim, Seung Woo Do, and Yong Hyun Lee, Kyungpook National University, and Jae Geun Oh, Sun Hwan Hwang, and Jin Gu Lee, Hynix Semiconductor Inc

WP9-12-05

40 V High Voltage arbitrary waveform Pulse Generator at Automatic Parametric Tester Yang Pan, James Yu, Jay Kim, and Peter Griffiths, Keithley Instruments, Inc.

WP9-12-06 Student

An Experimental Method Allowing Quantifying and Localizing Failed Cells of an EEPROM CAST After a Retention Test Claire Le Roux, F. Lalande, R. Laffont, and G. Micolau, L2MP laboratory, L. Lopez and J.L. Ogier, STMicroelectronics, and A. Firiti, IMS laboratory

WP9-12-07

Dimensional Dependences of the Dynamic-NBTI with 1.2 nm N2O-ISSG Oxynitrides Chao Sung Lai and D.C. Huang, Chang Gung University, and S.S. Chung, National Chiao Tung University

WP9-13 - Nanoelectronics (CNTs nanowires graphene)

WP9-13-01

Charging Effect in Germanium Nanocrystals Embedded in a SiO2 Matrix Yang Liu, T. P. Chen, M. Yang, L. Ding, J. I. Wong, and Dong Gui, Chartered Semiconductor Manufacturing

WP9-13-02 Student*

Spontaneous Emission Modification Analysis of Hexagonally Shaped Nanowire Lasers Mohammad Azim Karami, Prof. Ali Afzali-Kusha, and Dr.Reza Faraji-Dana, University of Tehran

WP9-13-03

Electrical Sorting of Carbon Nanotube Transistors for Mass-Producible Bio-sensors Gyoung-Ho Buh, Jea-Ho Hwang, Eun-kyoung Jeon, Byoung-Kye Kim, Hye-Mi So, Dong-Won Park, Hyunju Chang, Ki-jeong Kong, and Jeong-O Lee, Korea Research Institute of Chemical Technology

WP9-13-04

RF Nanoelectromechanical Switch Employing Nanowires Mahmoud Al Ahmad, Sabrina Habtoun, Christian Bergaud, Monique Dilhan, David Bourrier, and Robert Plana, LAAS-CNRS

WP9-14 - Advanced Processing Technologies

WP9-14-01

Integrating TiN only Bottom Plate Metal-Insulator Metal Capacitor (MIMC) for Contamination Free Manufacturing Jagdish Prasad and Bruce Greenwood, AMI Semiconductor

WP9-14-02 Student*

Impact of Width Effect on Performance Enhancement in NMOSFETs with Silicon-Carbon Alloy Stressor and Stress CESL Wei-Ching Wang, Shin-Jiun Kuang, Shu-Tong Chang, Jacky Huang, and C.-F. Huang, National Chung Hsing University

WP9-14-03 Student

Improvement of Charge Programming and Retention by NH3 Plasma Treatment on Tunnel Oxide for SiO2/SixGe1-x/SiO2 Trilayer Memory Devices

Chao-Sung Lai, Kung-Ming Fan, and Meng-Chi Tsai, Chang Gung University, Yu-Ching Fang, Chung-Shan Institute of Science & Technology, Chi-Fong Ai, Institution of Nuclear Energy Research, and C. R. Chen, Material Science Service Corp.

WP9-14-04 Student

Low Resistivity Hafnium Nitride Thin Films as Diffusion Barriers for Cu Interconnects Roy Araujo, Xinghang Zhang, and Haiyan Wang, Texas A&M University

WP9-14-05 Student

Enhancement of Critical Dimension of Wet-etched Thick Insulator Holes in Triode CNT-FED Devices Hsiao-Fen Wei and Ging-Ho Hsiue, National Tsing Hua University, and Chin-Yh Liu, Kuo-Feng Chen, and Kuang-Chung Chen, Industrial Technology Research Institute

WP9-15 - Wide Band-Gap Semiconductors - Materials and Devices

WP9-15-01 Student

A New Self-heating Effects Model for 4H-SiC MESFETs Quanjun Cao, Yimen Zhang, Yuming Zhang, and Hui Guo, Xidian University

WP9-15-02

1-D Wavefunction Localization and Effective Quantum Wire Behavior Inside QWs Deposited on Textured GaN Materials Spilios Riyopoulos, SAIC and Theodore Moustakas, Boston University

WP9-15-03 Student

GaN MESFET Growth on Vicinal Sapphire by MOVPE Chieh-Chih Huang, Shoou-Jinn Chang, Jia-Ching Lin, and Sheng-Po Chang, National Cheng Kung University, and Yi-Cheng Cheng and Wen-Jen Lin, Chung Shan Institute of Science and Technology

WP9-15-04 Student

Gate Dielectric Engineering of Sub Quarter Micron AlGaN/GaN Metal Insulator Semiconductor Heterostructure Field Effect Ruchika Aggarwal, Dr. Anju Agrawal, Dr. Mridula Gupta, and Dr. R.S.Gupta, University of Delhi

WP9-15-05 Student

2-Dimensional Simulation and Characterization of Deep-Submicron AlGaN/GaN HEMTs for High Frequency Applications Parvesh Gangwani, Ravneet Kaur, Mridula Gupta, and R.S Gupta, UDSC, Sujata Pandey, Amity School of Engineering and Technology, and Subhasis Haldar, University of Delhi

WP9-15-06

Hydrodynamic Transport Parameters of Wurtzite ZnO from Analytic- and Full-Band Monte Carlo Simulation Enrico Furno, Francesco Bertazzi, Michele Goano, and Giovanni Ghione, Politecnico di Torino, and Enrico Bellotti, Boston University

WP9-15-07 Student

Two-Dimensional Analytical Sub-Threshold Modeling and Simulation of Gate Material Engineered HEMT For Enhanced Carrier Transport Efficiency

Sona P.Kumar, Rishu Chaujar, Mridula Gupta, and R.S.Gupta, UDSC, and Anju Agrawal, University of Delhi

WP9-15-08 Student

The Limiting Frontiers of Maximum DC Voltage at the Drain of SiC Microwave Power Transistors in Case of Class-A Power Amplifier.

Sher Azam and Q. Wahab, Linköping University, and R. Jonnson, Swedish Defense Research Agency

WP9-15-09

Plasmon-assisted Power Dissipation in GaN-based 2DEG Channels for Power HFETs A. Matulionis, J. Liberis, I. Matulioniene, M. Ramonas, and E. `ermukanis, Semiconductor Physics Institute

WP9-15-10 Student

Interface Study of Atomic-layer-deposited HfO2/NO-nitrided SiO2 Gate Dielectric Stack on 4H SiC Yanging Wu, Shurui Wang, Yi Xuan, Tian Shen, Peide D. Ye, and James A. Cooper Jr., Purdue University

WP9-15-11 Student

Effect of the Aspect Ratio in AlGaN/GaN HEMT s DC and Small Signal Parameters M. A. Huque, S. A. Eliza, T. Rahman, H. F. Huq, and S. K. Islam, The University of Tennessee

WP9-15-12

Evolution of Annealed Undoped Single Crystal ZnO Surfaces and Implications for Schottky Barrier Height Dr. Diane Elizabeth Pugel, NASA Goddard Space Flight Center, Dr. Shankar Dhar, Dr. R.D. Vispute, Dr. B. Varughese, Dr. I. Takeuchi, and Dr. T. Venkatesan, University of Maryland, and Dr. S.S. Hullavarad, University of Alaska

WP9-15-13 Student*

AlGaN/GaN HEMT without Schottky Contact on the Dry-etched Region for High Breakdown Voltage Young-Hwan Choi, Jiyong Lim, In-Hwan Ji, Kyu-Heon Cho, Young-Shil Kim, and Min-Koo Han, Seoul National University

WP9-15-14 Student*

Modeling and Design of a Monolithically Integrated Power Converter on SiC Liangchun Yu, Kuang Sheng, and Jian H. Zhao, Rutgers University

WP9-15-15

Implant Activation in GaN Using an AlN cap

Carl Hager IV, Dr. Ken A. Jones, M. D. Derenge, Dr. D. J. Ewing, and Dr. T. S. Zheleva, Army Research Laboratory

WP9-15-16 Student

Optical And Electrical Properties Of Al/ZnO-Nanocomposite/Si N-P Diodes Hasina Ali, Agis Iliadis, Luz Martinez-Miranda, and Saeed Esmaili Sardari, University of Maryland, and Unchul Lee, Army Research Laboratory

WP9-15-17

A New Ultra-Fast Charge Pumping Measurement Technique for NIT Characterization without Relaxation Daniel B. Habersat and Aivars J. Lelis, U.S. Army Research Laboratory, Moshe Gurfinkel, Tel Aviv University, Justin Horst. J. Kim, Hao Xiong, Charles Cheung, and John S. Suehle, NIST, and Joseph B. Bernstein and Yoram Shapira, University of Maryland

WP9-15-018 Student

Projections of Schottky Barrier Source-Drain Gallium Nitride MOSFET Based on TCAD Simulation and Experimental Results A. Merve Ozbek, Matthew T. Veety, Michael Morgensen, Lei Ma, M.A.L. Johnson, and Doug W. Barlage, North Carolina State University

WP9-15-19

Pseudo Quantum Dot Behavior Due to Excitonic Transitions in Wide Gap Quantum Wire Lasers: InGaN-AlGaN and ZnCdSe-Wenli Huang, US Military Academy and Faquir Jain, University of Connecticut

WP9-15-20 Student

Simultaneous Study of Nickel Based Ohmic Contacts to Si-face and C-face of n-type Silicon Carbide Reza Ghandi, H-S. Lee, M. Domeij, C-M. Zetterling, and M. Östling, Royal Institute of Technology

WP9-15-21

Evaluation of 4H-SiC DMOSFETs for Power Converter Applications Ronald Green, Damian Urciuoli, Aderinto Ogunniyi, Gail Koebke, Lauren Everhart, Dimeji Ibitayo, and Aivars Lelis, Army Research Laboratory

WP9-15-22 Student

Effect of P-type Cladding Layer and P++-GaN Layer of InGaN/GaN MQWs Blue LED Ray-Ming Lin, Chun-Wei Liao, Yung-Hsiang Lin, Cheng-Ying Yen, Pei-Wen Liu, and Yuan-Chieh Lu, Chang Gung University

WP9-15-23 Student

Normally-Off AlGaN/GaN HEMTs with InGaN Cap Layer: A Theoretical Study Stanislav Vitanov and Vassil Palankovski, Technical University Vienna

WP9-15-24

Investigation of Nanocrystalline Diamond Films as Ohmic Contacts to GaN Marko J. Tadjer, University of Maryland, Karl D. Hobart, Joshua D. Caldwell, Michael A. Mastro, James E. Butler, Dimitri A. Alexson, and Fritz J. Kub, Naval Research Laboratory, and Tatyana I. Feygelson, SAIC, Inc.

WP9-15-25 Student

Thermal Stability of 5 nm Barrier InAlN/GaN HEMTs Farid Medjdoub, University of Ulm

WP9-16 - High Frequency/THz Devices

WP9-16-01 Student

Design and Modeling of a High fT and fmax Heterojunction Bipolar Transistor Pik-Yiu Chan and Faquir Jain, University of Connecticut

WP9-16-02

Complex Permittivity and Permeability of Single- and Multi-walled Carbon Nanotubes at High Microwave Frequencies and Quantifying Microwave Absorption

Sanju Gupta, University of Missouri, and N. Al Moayed, U. Khan, M. Obol, and M. Afsar, Tufts University

WP9-16-03

Auxiliary Resistive Components for Millimeter to Sub-millimeter Astronomical Observatories Ari-David Brown, James Chervenak, David Chuss, Ross Henry, Vilem Mikula, and Edward Wollack, NASA Goddard Space Flight Center

WP9-17 - Si/Ge Devices and Materials

WP9-17-01 Student

Design and Simulation of Strained Si/SiGe Dual Channel MOSFETs Puneet Goyal, James E. Moon, and Santosh K. Kurinec, Rochester Institute of Technology

WP9-17-02 Student

Impacts of a Buffer Layer and Hi-wafers on the Performance Yao-Jen Lee and Fu-Kuo Hsueh, National Nano Device Laboratories, Tzu-I Tsai, King-Sheng Chen, Chia-Chen Wan, Horng-Chih Lin, Tien-Sheng Chao, and Tiao-Yuan Huang, National Chiao Tung University, and Jeff Wang, University of Waterloo

WP9-17-03 Student

Reliability of Strained-channel NMOSFETs with SiN Capping Layer on Hi-wafers with a thin LPCVD-TEOS buffer layer Yao-Jen Lee and Fu-Kuo Hsueh, National Nano Device Laboratories, Tzu-I Tsai, King-Sheng Chen, Chia-Chen Wan, Horng-Chih Lin, Tien-Sheng Chao, and Tiao-Yuan Huang, National Chiao Tung University, and Jeff Wang, University of Waterloo

WP9-17-04 Student*

Strained-Si:C-Source/Drain NMOSFETs for Channel Strain Enhancement M. H. Lee, K.-W. Shen, R.-S. Syu, C.-F. Huang, and Y.-T. Liu, National Taiwan Normal University, S. T. Chang, National Chung Hsing University, and S. Maikap, Chang-Gung University

WP9-17-05 Student

Impacts of Precursor Flow Rate and Temperature of PECVD-SiN Capping Films on Strained-Channel NMOSFETs Ching-Sen Lu, Horng-Chih Lin, and Tiao-Yuan Huang, National Chiao Tung University, and Yao-Jen Lee, National Nano Device Laboratories

WP9-17-06 Student

The Effect of Ge Mole Fraction on the Electrical Characteristics of Nanoscale Si/SiGe Hetrostructure pMOSFET Morteza Fathipour, University of Tehran, Behrooz Abbaszadeh and Fatemeh Kohani, Islamic Azad University Tehran and Farzan Farbiz, University of Illinois at Urbana Champaign

WP9-17-07 Student

Comparisons on Performance Improvement by Nitride Capping Layer among Different Channel Directions nMOSFETs Yao-Jen Lee and Fu-Kuo Hsueh, National Nano Device Laboratories, Tzu-I Tsai, King-Sheng Chen, Tiao-Yuan Huang, and Horng-Chih Lin, National Chiao Tung University, and Jeff Wang, University of Waterloo

WP9-17-08 Student

Core-shell Germanium-Silicon Nanoparticle Structure for High K Nonvolatile Memory Applications Hai Liu, Wyatt Winkenwerder, Yueran Liu, Scott K. Stanley, John G. Ekerdt, and Sanjay K. Banerjee, University of Texas

WP9-17-09 Student

Phonon Heat Dissipation in Silicon

Zlatan Aksamija and Umberto Ravaioli, University of Illinois

WP9-18 - Optoelectronics and Photonics

WP9-18-01

CMOS-compatible Light Emission Device Based on Thin Aluminum Nitride Film Containing Al Nanocrystals Yang Liu, T. P. Chen, M. Yang, Z. Liu, L. Ding, and S. Zhang, Nanyang Technical University

WP9-18-02

High-gain Optoelectronic Amplification Circuit for Integrated Optical Detector Weidong Yang, The 24th Institute, CETC and Zhengfan Zhang and Kaicheng Li, National Key Labs of Analog Integrated Circuits

WP9-18-03

Diamondoids in Nanotechnology: First-principles Simulation of Electronic Structure and Nonlinear Optical Response in Adamantane

Thomas George, University of Missouri-St. Louis, Guoping Zhang, Indiana State University, G. Ali Mansoori, University of Illinois at Chicago, and Lahsen Assoufid, Argonne National Laboratory

WP9-18-04 Student

The Electrical Characteristic of Commercial GaN Blue Light Emitting Diode Noorah Ahmaed AlAhmadi, King Fahd Medical Research Center, Ian Harrison, University of Nottingham UK, and K.H.Badr, Naval Institute, Jeddah

WP9-18-05 Student*

Design and Characterization of a Gain-Enhanced Floating Gate-body Tied Photodetector in Silicon on Sapphire CMOS Miriam Adlerstein Marwick and Andreas G. Andreou, Johns Hopkins University

WP9-18-06

Integrated CMOS Photo-transistor Array for Visual Light Identifier(ID) Yoshinori Matsumoto, Takaharu Hara, and Yohsuke Kimura, Keio University

WP9-18-07 Student

Maximum Number of Longitudinal Modes Oscillating in a Quantum Dot Laser due to Spatial Hole Burning Li Jiang and Levon V. Asryan, Virginia Polytechnic Institute and State University

Thursday, December 13, 2007

TA1: SiC Power Electronic Devices - 8:00am - 10:00am *Chairperson: Dr. Karl Hobart, NRL*

Co-chairperson: Dr. David Singh, US Army RDECOM Meeting Room: Colony Ballroom

8:00am - 8:30am	TA1-01 Invited Challenges in SiC Power MOSFET Design Kevin Matocha, GE Global Research Center
8:30-am - 8:50am	TA1-02 Status of 1200V 4H-SiC Power DMOSFETs Brett A. Hull, Mrinal K. Das, Sei-Hyung Ryu, Sarah K. Haney, Charlotte Jonas, Craig Capell, Len Hall, Jim Richmond, Robert Callanan, Fatima Husna, and Anant Agarwal, Cree, Inc., and Aivars Lelis, Bruce Geil, and Charles Scozzie, Army Research Laboratory
8:50am - 9:10am	TA1-03 Demonstration of 10 kV, 50A 4H-SiC DMOSFET with Stable Subthreshold Characteristics across 25-200 °C Operating Temperatures Robert S. Howell, Steven Buchoff, Stephen Van Campen, Ty McNutt, Bettina Nechay, and Marc Sherwin, Northrop Grumman, and Ranbir Singh, GeneSiC
9:10am - 9:30am	TA1-04 Exploring the Design Space of Rugged Seven Lithographic Level Silicon Carbide Vertical JFETs for the Development of 1200- V, 50-A Devices Victor Veliadis, Megan McCoy, Eric Stewart, Ty McNutt, Steve Van Campen, and Paul Potyraj, Northrop Grumman, and Charles Scozzie, Army Research Laboratory
9:30am - 10:00am	TA1-05 <i>Invited</i> Demonstration of the First Power IC on 4H-SiC Jian Zhao, Y. Zhang, M. Su, and K. Sheng, Rutgers University, and P. Alexandrov and L. Fursin, United Silicon Carbide, Inc.
TA2: Advanced Chairperson: D Meeting Room:	d Processing - 8:00am - 10:00am r. Lloyd Harriott, University of Virginia Benjamin Banneker Room
8:00am - 8:20am	TA2-01 Computational Lithography for Nanostructure Science and Technology Martin Peckerar, David Sander, Ankur Srivastava, and Adakou Foli, University of Maryland
8:20am - 8:40am	TA2-02 Impact of Solid Phase Epitaxial Regrowth on Device Performance for Non-Diffusive Flash-Annealed 45nm SOI-MOSFETs Ralf Illgen, T. Herrmann, S. Flachowsky, W. Klix, and R. Stenzel, University of Applied Sciences Dresden, and T. Feudel, M. Horstmann, L. Herrmann, and N.W. Hauptmann, AMD Saxony LLC & Co. KG
8:40am - 9:00am	TA2-03 Student* Source/Drain-Extension-Last Process for Incorporating In Situ Doped Lattice-Mismatched Extension Stressor for Enhanced Performance in SOI N-FET Wong Hoong Shing, Kah-Wee Ang, Lap Chan, Ganesh Samudra, and Yee-Chia Yeo, National University of Singapore, Keat- Mun Hoe, Chih-Hang Tung, and N.Balasubramaniam, Institute of Microelectronics, and Doran Weeks, Trevan Landin, Jennifer Spear, and Shawn G. Thomas, ASM America Inc
9:00am - 9:20am	TA2-04 Student Characteristics and Thermal Stability of MOS devices with Metal Gate Stacks of MoN and TiN Kuei-Shu Chang-Liao, Chong-Hao Fu, and Po-Yen Chien, National Tsing Hua University
9:20am - 9:40am	TA2-05 Characterization of CoxNiyO Bimetallic Oxide Nanoparticles as Charge Trapping Nodes in Nonvolatile Memory Devices Chin-Lung Cheng, Jin-Tsong Jeng, and Sung-Wei Huang, National Formosa University, Kuei-Shu Chang-Liao and Ping- Hung Tsai, National Tsing Hua University, and Chien-Wei Liu and Bau-Tong Dai, National Nano Device Laboratories
9:40am - 10:00am	TA2-06 Investigation into Key Technologies of 12-bit DA Converter Weidong Yang, Ruzhang Li, and Yong Liu, NLAIC

TA3: Applications of Nanoscale Devices - 8:00am - 10:00am

Chairperson: Dr. Gary Pennington, ARL

Meeting	Room:	Juan	Jimenez	Room
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8:00am - 8:20am	TA3-01 Student An Empirical Study of Dynamic Properties of an Individual Carbon Nanotube Electron Source System Mahmud Rahman and Norman G. Gunther, Santa Clara University, Bryan P. Ribaya and Darrell L. Niemann, Santa Clara University / NASA Ames Research Center, Joseph Makarewicz, NASA Ames Research Center, and Cattien V. Nguyen, ELORET Corporation / NASA Ames Research Center
8:20am - 8:40am	TA3-02 Metallic Multiwalled Carbon Nanotubes for Microwave Applications Mahmoud Al Ahmad and Robert Plana, LAAS-CNRS, and Abbes Tahraoui and Bill Milne, University of Cambridge
8:40am - 9:00am	TA3-03 <i>Student</i> Digitally Addressable Vertically Aligned Carbon Nanofibers for Implementation of Massively Parallel Maskless Lithography S. A. Eliza, S. K. Islam, T. Rahman, R. Vijayaraghavana, T. Grundman, and B. Blalock, The University of Tennessee, and S. J. Randolph, L. R. Baylor, T. S. Bigelow, W. L. Gardner, M. N. Ericson, and J. A. Moore, Oak Ridge National Laboratory
9:00am - 9:20am	TA3-04 Student A Bio-Inspired Image Processor for Edge Detection with Single-Electron Circuits Andrew Kilinga Kikombo, Tetsuya Asai and Yoshihito Amemiya, Graduate School of Information Science and Technology, Hokkaido University Alexandre Schmid and Yusuf Leblebici, Swiss Federal Institute of Technology (EPFL)
9:20am - 9:40am	TA3-05 Student A Semi Empirical Model of Vertically Aligned Carbon Nanofiber for Field Emission Devices for Circuit Application Touhidur Rahman, S. A. Eliza, S. K. Islam, and T. R. Grundman, The University of Tennessee, and L. R. Baylor, Oak Ridge National Laboratory
TA4: Statistic Chairperson: L Meeting Room:	cal and Technology Modeling - 8:00am - 10:00am Dr. Christoph Jungemann, Bundeswehr Univeristy Charles Carroll Room
8:00am - 8:20am	TA4-01 Strain-Induced Anisotropy of Electromigration in Copper Interconnect Roberto Lacerda de Orio, Hajdin Ceric, and Siegfried Selberherr, Institute for Microelectronics - TUWien
8:20am - 8:40am	TA4-02 A Simple Hardware-Based Statistical Model on 65nm SOI CMOS Technology Qingqing Liang, Jim Johnson, Joseph Walko, Ming Cai, Yanfeng Wang, Ronald Logan, David Fried, Gregory Freeman, Edward Maciejewski, Edward Nowak, Scott Springer, and Effendi Leobandung, IBM SRDC
8:40am - 9:00am	TA4-03 Student Predictive Technology Modeling for 32nm Low Power Design Yu Cao and Wei Zhao, Arizona State University, and Xia Li and Matt Nowak, Qualcomm Inc.
9:00am - 9:20am	TA4-04 Student Modeling the Thermal Behavior of Chalcogenide based Phase Change Memory cell Archana Devasia and Santosh Kurinec, Rochester Institute of Technology
9:20am - 9:40am	TA4-05 <i>Student</i> Sensitivity of Static Noise Margins to Random Doping Variations in 6T SRAM Cells

Liviu Oniciuc, Florida State University, and Petru Andrei, Florida A&M University and Florida State University 9:40am - 10:00am TA4-06 Invited

Electrical and Thermal Transport in Metallic Single-Wall Carbon Nanotubes Eric Pop, University of Illinois

10:00am - 10:45am Coffee Break - Grand Ballroom

TA5: Wide Bandgap Materials - 10:15pm - 12pm

Chairperson: Dr. Charles Eddy, NRL Meeting Room: Colony Ballroom

10:15am - 10:45am TA5-01 Invited

Silicon Carbide Avalanche Photodiodes Joe C. Campbell, Han-Din Liu, Dion McIntosh, and Xiaogang Bai, University of Virginia

10:45am - 11:05am TA5-02

Bulk GaN-Based Schottky Rectifier and UV Photodetector Minseo Park, Y. Zhou, C. Ahyi, D. Wang, C. C. Tin, and J. Williams, Auburn University, and N. M. Williams, A. D. Hanser, E. A. Preble, and K. Evans, Kyma Technologies, Inc.

11:05am - 11:25am TA5-03 Student*

Ultrathin MBE-Grown AlN/GaN HEMTs with Record High Current Densities Yu Cao, Tom Zimmermann, David Deen, John Simon, Jeff Bean, Ning Su, Jing Zhang, Patrick Fay, Huili Xing, and Debdeep Jena, University of Notre Dame

11:25am -11:45am TA5-04 Student

Analysis of AlGaN/GaN HEMT Modulated by Photosystem I Reaction Centers Sazia Afreen Eliza and Syed K. Islam, The University of Tennessee, and Ida Lee and Elias Greenbaum, Oak Ridge National Laboratory

11:45am - 12:05pm TA5-05

Influence of Shockley Stacking Fault Propagation and Contraction on Electrical Behavior of 4H-SiC pin diodes and DMOSFETs Joshua D. Caldwell, Robert E. Stahlbush, Orest J. Glembocki, Karl D. Hobart, Eugene A. Imhoff, and Kendrick X. Liu, Naval

Joshua D. Caldwell, Robert E. Stahlbush, Orest J. Glembocki, Karl D. Hobart, Eugene A. Imhoff, and Kendrick X. Liu, Naval Research Laboratory, and Marko J. Tadjer, University of Maryland

12:05pm - 12:25pm TA5-06

Physical and Optical Characterization of GaN Doped with Neodymium grown by Plasma-Assisted Molecular Beam Epixaty Eric D. Readinger, Grace D. Chern-Metcalfe, Hongen Shen, Mark Wood, and Michael Wraback, U.S. Army Research Laboratory, and Volkmar Dierolf, Leigh University

TA6: Silicon on Insulator - 10:15am - 12pm

Chairperson: Dr. Dimitris E. Ioannou, George Mason University Co-Chairperson: Dr. Marvin White, Lehigh University Meeting Room: Benjamin Banneker Room

10:15am - 10:45am TA6-01 Invited

Advanced Semiconductor on Insulator Substrates for LP and HP Digital CMOS applications Bich-Yen Nguyen, Gearge Celler, Ian Cayrefourcq, Paul Paltruno, and Carlos Mazure, Soitec

10:45am - 11:15am TA6-02 Invited

Transport in Ultra-Thin-Body SOI and Silicon Nanowire MOSFETs Toshiro Hiramoto, Gen Tsutsui, Ken Shimizu, and Masaharu Kobayashi, University of Tokyo

11:15am - 11:35am TA6-03

Large Current Enhancement in n-MOSFETs with Strained Si on Insulator Siegfried Mantl, D.Buca, Q.T. Zhao, B. Holländer, S. Feste, and M.Luysberg, Research Center Juelich, IFF, M. Reiche and U. Gösele, Max Planck Institute of Microstructure, W. Buchholtz, A. Wei, and M. Horstmann, AMD Saxony LLC & Co. KG, and R. Loo, and D. Nguyen, IMEC

11:35am -11:55am TA6-04 Student

Design and Optimization of the SOI Field Effect Diode (FED) Yang Yang and Dimitris E. Ioannou, George Mason University, and Akram A. Salman and Stephen G. Beebe, Advanced Micro Devices

11:55am - 12:15pm TA6-05

Material Choice for Optimum Stress Memorization in SOI CMOS Processes Andreas Gehring, AMD Saxony LLC & Co. KG

TA7: Physics of Nanoelectronic Devices - 10:15am - 12pm

Chairperson: Dr. Matthew Ervin, ARL Meeting Room: Juan Jimenez Room

10:15am - 10:35am TA7-01 Student

Electromechanical Response of Silicon Nanowires: Bandgap and Effective Mass Daryoush Shiri, Yifan Kong, Andrei Buin, and M. P. Anantram, University of Waterloo

10:35am - 110:55am TA7-02

Monte Carlo Simulation of Hot Optical Phonon Decay in a Carbon Nanotube Gary Pennington, Steve J. Kilpatrick, and Alma E. Wickenden, Army Research Laboratory

10:55am - 11:15am TA7-03 Student

A Nonparabolicity Model Compared to Tight-Binding: The Case of Square Silicon Quantum Wires Aniello Esposito, ETH Zurich, Mathieu Luisier, Martin Frey, and Andreas Schenk, Integrated Systems Laboratory, ETH Zurich and Synopsys LLC.

11:15am -11:35am TA7-04 Student

A Fast Semi-numerical Technique for the Solution of the Poisson-Boltzmann Equation in a Cylindrical Nanowire Ashok T. Ramu and Kaustav Banerjee, University of California, Santa Barbara, and Manjeri P. Anantram, University of Waterloo

11:35am - 11:55pm TA7-05

Enhancement of Hole Mobility Due to Confinement in Small Diameter [110] Silicon Nanowires Andrei Buin and Manjeri P. Anantram, University of Waterloo, and Amit Verma, Texas A&M University

11:55pm - 12:15pm TA7-06 Student

Modeling and Analysis of Intrinsic Gate Capacitance for Carbon Nanotube Array Based Devices Considering Screening Effect and Diameter Variations

Chaitanya Kshirsagar and Kaustav Banerjee, University of California, Santa Barbara, and Tom Kopley, Agilent Laboratories

TA8: Compact Modeling - 10:15am - 12pm

Chairperson: Dr. Allen Hefner, NIST Meeting Room: Charles Carroll Room

10:15am - 10:35am TA8-01

Closed-Form Physics-Based Models for Threshold Voltage and Subthreshold Slope in FinFETs Including 3D Effects Alexander Kloes and Michaela Weidemann, University of Applied Sciences Giessen-Friedberg, and Bryan T. Bosworth, Princeton University

10:35am - 110:55am TA8-02 Student

Physics-Based Modeling of Output Conductance in Nanoscale Bulk MOSFET by Analytically Solving 2D Poisson Michaela Weidemann and Alexander Kloes, University of Applied Sciences Giessen-Friedberg, and Benjamin Iniguez, Universitat Rovira i Virgili

10:55am - 11:15am TA8-03 Student

An Analytical Extraction Method for Scalable Substrate Resistance Model in RF MOSFETs Shih-Ping Kao, Chih-Yuan Lee, Chuan-Yu Wang, Chen-Chai Chang, and Chin-Hsing Kao, National Defense University, and Joseph Der-Son Deng, Chung-Shan Institute of Science and Technology

11:15am -11:35am TA8-04

Analytic Diffusion and Drift Components of Drain Current for Double Gate MOSFETs Chun-Hsing Shih, Yuan Ze University, and Jhong-Sheng Wang, National Tsing Hua University

11:35am - 11:55pm TA8-05 Student

Temperature Dependent Empirical Modeling of Proximity Diffused Si Esaki Diodes and Memory Circuits David Pawlik, Sankha Mukeerji, Ray Krom, Shrini Pandharpure, Santosh Kurinec, and Sean Rommel, Rochester Institute of Technology, and Remesh Anisha and Paul Berger, Ohio State University

11:55pm - 12:15pm TA8-06 Student

Physics Based Current and Capacitance Modeling of Short-Channel Double Gate MOSFETs Håkon Børli, Sigbjørn Kolberg, and Tor A. Fjeldly, Norwegian University of Science and Technology

12pm - 1pm Box Lunch - Grand Ballroom

Plenary Session - 1pm - 3:30pm

Chairperson: Dr. Neil Goldsman, University of Maryland Meeting Room: Colony Ballroon

PL1 Invited

Challenges and Opportunities of Emerging Nanotechnology for Future VLSI Nanoelectronics Dr. Robert Chau, Intel Corporation

PL2 Invited

The Ultimate MOSFET and the Limits of Miniaturization Dr. Mark S. Lundstrom, Purdue University School of Electrical and Computer Engineering

PL3 Invited

The Coming Revolution in RF Electronics Dr. Mark Rosker, DARPA

3:30pm - 3:45pm Coffee Break - Grand Ballroom

TP1: Performance and Reliability of III-Nitride RF Devices - 3:45pm - 5:45pm

Chairperson: Dr. Mark Rosker, DARPA Meeting Room: Colony Ballroom

3:45pm - 4:05pm	TP1-01 0.18 um Double-Recessed III-Nitride Metal-Oxide Double Heterostructure Field-Effect Transistors Vinod Adivarahan, Mikhail Gaevski, MD Monirul Islam, Naveen Tipirneni, Bin Zhang, Yanqing Deng, Zijiang Yang, and Asif Khan, University of South Carolina
4:05pm - 4:25pm	TP1-02 Low-Loss High-Power AlInGaN RF Switches Grigory Simin, Univeristy of South Carolina, Xuhong Hu, Jinwei Yang, and Remis Gaska, Sensor Electronic Technology, Inc., and Zijiang Yang and Michael Shur, Rensselaer Polytechnic Institute
4:25pm - 4:45pm	TP1-03 Student Gate I-V Characteristics Degradation in AlGaN/AIN/GaN HEMTs Lingjia Li and Marek Skowronski, Carnegie Mellon University
4:45pm - 5:05pm	TP1-04 Student* Extraction of Effective Trap Density and Gate Length in AlGaN/GaN HEMTs Based on Pulsed I-V Characteristics Hyeongnam Kim and Wu Lu, The Ohio State University
5:05pm - 5:25pm	TP1-05 Current Collapse and Reliability Mechanisms in GaN HEMTs Alexei Koudymov and Michael S. Shur, Rensselaer Polytechnic Institute, and Grigory S. Simin, University of South Carolina

TP2: Si/Ge Materials and Devices - 3:45pm - 5:45pm

Chairperson: Dr. Paul Berger, Ohio State University Meeting Room: Benjamin Banneker Room

3:45pm - 4:05pm	TP2-01
	Monocrystalline SiGe for High-performance Uncooled Thermistor
	Stanley G. E. Wissmar, C. Vieider, and J.Y. Andersson, Acreo AB, M. Kolahdouz, and H.H. Radamsson, Royal Institute of
	Technology, and Y. Yamamoto, and B. Tillack, IHP
4:05pm - 4:35pm	TP2-02 Invited
	Carrier-Transport-Enhanced CMOS using New Channel Materials and Structures
	Shinichi Takagi and Mitsuru Takenaka, The University of Tokyo, and Toshifumi Irisawa, Tsutomu Tezuka, Shu Nakaharai,
	Koji Usuda, Norio Hirashita, and Naoharu Sugiyama, MIRAI-ASET
4:35pm - 4:55pm	TP2-03
	Simplified Si Resonant Interband Tunnel Diodes
	Phillip E. Thompson and Glenn Jernigan, Naval Research Laboratory, Si-Young Park, Ronghua Yu, R. Anisha, and Paul
	Berger, Ohio State University, and David Pawlik, Raymond Krom, and Sean Rommel, Rochester Institute of Technology

4:55pm - 5:35pm TP2-04 Student*

Anneal Time Study of Si Resonant Interband Tunnel Diodes Grown by Low-Temperature Molecular-Beam Epitaxy R. Krom, D. Pawlik, S. Muhkerjee, S. Pandharpure, S. K. Kurinec, and S. L. Rommel, Rochester Institute of Technology, S-Y Park, R. Yu, R. Anisha, and P. R. Berger, Ohio State University, and P. E. Thompson, Naval Research Laboratory

5:35pm - 5:55pm TP2-05 Student

Germanium Profile, Graduality and Base Doping Level Influences in the Performance of SiGe HBT Eloy Ramirez-Garcia, Nicolas Zerounian, and Frederic Aniel, Universite Paris Sud XI, Mauro A. Enciso Aguilar, Instituto Politecnico Nacional, and Benoit Barbalat, Pascal Chevalier, and Alain Chantre, STMicroelectronics

TP3: MEMS - 3:45pm - 5:45pm

Chairperson: Dr.Reza Ghodssi University of Maryland

 Meeting Room:
 Juan Jimenez Room

 3:45pm - 4:05pm
 TP3-01

 NEMS Switch with 30 nm Thick Beam and 20 nm High Air Gap for High Density Non-Volatile Memory Applications Min-Sang Kim, Samsung Electronics Co., and Weon Wi Jang, KAIST

 4:05pm - 4:25pm
 TP3-02 Student* Toward Smart Micromachines with Integrated Feedback Control Reza Ghodssi, Mustafa Ilker Beyaz, and Nima Ghalichechian, University of Maryland

 4:25pm - 4:55pm
 TP3-03 Invited Applications of BioMEMS in Cell-Related Research Svetlana Tatic-Lucic, Lehigh University

4:55pm - 5:15pm TP3-04 Student

Amorphous SiC as a Structural Layer in Microbridge-based RF MEMS Switches for Use in Software-Defined Radio Rocco J. Parro, Sloan Zimmerman, and Christian A. Zorman, Case Western Reserve University, and Maximilian C. Scardelletti and Nicholas C. Varaljay, NASA Glenn Research Center at Lewis Field

5:15pm - 5:35pm TP3-05 Student

Low Frequency Noise Measurement of Three-Axis Surface Micro-Machined Silicon Capacitive Accelerometer Faisal Mohd-Yasin, DS Ong, and HT Chuah, Multimedia University, and DJ Nagel and CE Korman, The George Washington University

TP4: Device Simulations - 3:45pm - 5:45pm

Chairperson: Dr. Tibor Grasser, TU Vienna Meeting Room: Charles Carroll Room

3:45pm - 4:05pm	TP4-01 Ballisticity of the Linear Response Transport in Nanometric Silicon Devices <i>Christoph Jungemann, Bundeswehr University</i>
4:05pm - 4:25pm	TP4-02 Student* Efficient Simulation of Hole Transport in Strained Si and SiGe on Insulator Inversion Layers Anh-Tuan Pham, Matthias Klawitter, and Bernd Meinerzhagen, Technical University of Braunschweig, and Christoph Jungemann, Bundeswehr University
4:25pm - 4:45pm	TP4-03 Two-band k.p Model for the Conduction Band in Silicon: Impact of Strain and Confinement on Band Structure and Mobility Viktor Sverdlov, Gerhard Karlowatz, Siddhartha Dhar, Hans Kosina, and Siegfried Selberherr, Intitute for Microelectronics, TU Wien
4:45pm - 5:05pm	TP4-04 Smart-Power Device Model Coupling Compact, Distributed and Logic Level Description Alberto Castellazzi and Mauro Ciappa, Swiss Federal Institute of Technology Zurich (ETH Zurich)
5:05pm - 5:25pm	TP4-05 Student* Impact of Source to Drain Tunneling on the Ion/Ioff trade-off Quentin Rafhay, Raphaël Clerc, Gérard Ghibaudo, and Georges Pananakakis, IMEP - Minatec - INPG
5:25pm - 5:45pm	TP4-06 Student A 2D-Non-Parabolic Six Moments Model Martin Vasicek, TU Vienna
6:15pm - 9:15pm	Symposium Awards Banquet - Grand Ballroom

Friday, December 14, 2007

FA1: SiC MOS Technology and Issues - 8am - 10am Chairperson: Dr. Aivars Lelis, ARL Co-chairperson: Dr. Anant Agarwal, CREE Meeting Room: Colony Ballroom 8:00am - 8:30am FA1-01 Invited Technical Challenges in Commercial SiC Power MOSFETs Anant Agarwal, Cree Inc. 8:30am - 8:50am FA1-02 Time Dependence of Bias-Stress Induced Threshold-Voltage Instability Measurements Aivars Lelis, Dan Habersat, Ron Green, and Aderinto Ogunniyi, U.S. Army Research Laboratory, Moshe Gurfinkel, and John Suehle, NIST, and Neil Goldsman, University of Maryland 8:50am - 9:10am FA1-03 Student Electrically Detected Magnetic Resonance Studies of Processing Variations in 4H SiC Based MOSFETs Corey Cochrane and Patrick Lenahan, Penn State University, and Aivars Lelis, Army Research Lab 9:10am - 9:25am FA1-04 Student Atomic Scale Defects in 4H SiC/SiO2 using Electron Spin Resonance Aaron Rape and Patrick Lenahan, Penn State University, and Aivars Lelis, Army Research Lab 9:25am - 9:45am FA1-05 Student Characterization of the Origin of Band States in the SiC/SiO2 Interface Trinity L. Biggerstaff, and Ryan D. McClellan, North Carolina State University, A. Lelis, and T. Zheleva, Army Research Laboratory, Sarah Haney and Anant Agerwal, Cree, Inc., Wolfgang Windl, Ohio State University, and Sanwu Wang, University of Tulsa 9:45am - 10:00am FA1-06 Student High Temperature High Field Numerical Modeling and Experimental Characterization of 4H-SiC MOSFETs Siddharth Potbhare and Neil Goldsman, University of Maryland, and Aivars Lelis, US Army Research Laboratory FA2: High Frequency I - 8am - 10am Chairperson: Dr. Michael Shur, RPI Meeting Room: Benjamin Banneker Room 8:00am - 8:30am FA2-01 Invited Picosecond Electrical Soliton Oscillators & THz Electronics Donhee Ham and Omer Ozgur Yildirim, Harvard University 8:30am - 9:00am FA2-02 Invited Conduction-Band Spin Splitting Effects in Staggered-Bandgap Structures Weidong Zhang, North Carolina State University, and Dwight Woolard, U.S. Army Research Office 9:00am - 9:20am FA2-03 Plasma wave FET for sub-wavelength THz imaging Dmitry Veksler, A. V. Muraviev, T. A. Elkhatib, K. N. Salama, and M. S. Shur, Rensselaer Polytechnic Institute 9.20am - 9:40am FA2-04 Selective Doping and Optimization of InGaN Channel and InGaN Back-barrier in Deep Submicron GaN Heterojunction Field Effect Transistor with a Recessed Gate Yanqing Deng, Vinod Adivarahan, and Asif Khan, University of South Carolina

9:40am - 10:00am FA2-05 Tunable Optically Pumped High Power Terahertz Laser on Cyclotron Resonance in Semiconductors Dmitry Veksler, Andrei Muraviev, and Michael Shur, Rensselaer Polytechnic Institute, and Valery N. Shastin, Institute for Physics of Microstructures

FA3: Manufa Chairperson: L	acturing Issues of Nanoelectronic Devices - 8am - 10am Dr. Keith Perkins, NRL
8:00am - 8:20am	 FA3-01 Student* Silicon Nanowire Memory Application Using Hafnium Oxide Charge Storage Layer Xiaoxiao Zhu, Qiliang Li, Dimitris E. Ioannou, and Shuo Yang, George Mason University, and William A. Kimes, John S. Suehle, James E. Maslar, Hao D. Xiong, and Curt A. Richter, NIST
8:20am - 8:40am	FA3-02 Student Performance Analysis of Multi-Walled Carbon Nanotube Based Interconnects Hong Li and Kaustav Banerjee, University of California, Santa Barbara, and Wen-Yan Yin and Jun-Fa Mao, Shanghai Jiao Tong University
8:40am - 9:00am	FA3-03 Single Charge Detection Using Single-Walled Carbon Nanotube Single-Hole Transistor Takafumi Kamimura, Yasuhide Ohno, and Kazuhiko Matsumoto, Osaka University
9:00am - 9:20am	FA3-04 <i>Student</i> Dynamic C-V and G-V Characteristics of Metal-Insulator-Semiconductor Capacitor with Au Nanocrystals and high-K Tunneling Layer <i>Kuang-Hao, Chiang, H. C. Wu , and C.H. Kuan, National Taiwan University, P. S. Chen and Ming Hsin, University of Science</i> <i>and Technology, and C. S. Tsai, University of California</i>
9:20am - 9:40am	FA3-05 Impact of High-κ Dielectric and Metal Nanoparticles in Simultaneous Enhancement of Programming Speed and Retention Time of Nano-Flash Memory Akeed A. Pavel, Mehjabeen A. Khan, Phumin Kirawanich, and Naz Islam, University of Missouri-Columbia
9:40am - 10:00am	FA3-06 Student Silicon Nanowire Fabrication Using Novel Hydrogenation-Assisted Deep Reactive Ion Etching Amir Sammak, Soheil Azimi, Shams Mohajerzadeh, Bahar Khadem-Hosseinieh, and Babak Fallah-Azad, University of Tehran

10:00am - 10:15am Coffee Break - Grand Ballroom

FA4: Organic Materials and Devices - 8am - 10am

Chairperson: Dr. David Gundlach, NIST

Meeting Room: Charles Carroll Room

8:00am - 8:20am	FA4-01 Achieving High Mobilities in Solution-Processable Organic FETs by Minimizing Contact Effects Behrang H. Hamadani and David J. Gundlach, NIST, and Iain McCulloch, and Martin Heeney, Merck Chemicals
8:20am - 8:40am	FA4-02 Bottom Contact Organic Transistor Based On Air-Stable N-Type F15-Ntcdi Jia Sun, Kevin See and Howard E. Katz, Johns Hopkins University
8:40am - 9:00am	FA4-03 Influence of the Film Microstructure on the Electronic Properties and Flicker Noise in Organic Thin Film Transistors Oana D. Jurchescu, Sungkyu K. Park, and Thomas N. Jackson, Penn State University, Behrang H. Hamadani, Hao D. Xiong, Neil M. Zimmerman, and David J. Gundlach, NIST, and Sankar Subramanian and John Anthony, University of Kentucky
9:00am - 9:20am	FA4-04 Student A Novel Gated Transmission Line Method for Organic Thin Film Transistors Keum-Dong Jung, Byeong-Ju Kim, Yoo Chul Kim, Byung-Gook Park, Hyungcheol Shin, and Jong Duk Lee, Seoul National University
9:20am - 9:40am	FA4-05 Student* Metal Molecule GaAs Devices using Redox-Active Organic Self-Assembled Monolayers Rand K. Jean, Bin Xi, Tong Ren, and David B. Janes, Purdue University
9:40am - 10:00am	FA4-06 Student Thin Film Microstructure of Solution Processable Pyrene-based Small Molecules for Electronic Applications Leah Lucas and Ghassan E. Jabbour, Arizona State University, Bilal R. Kaafarani, American University of Beruit, and Dean M. DeLonchamp, Lee J. Richter, R. Joseph Kline, and Daniel M. Fischer, NIST

FA5: Wide Bandgap Materials - 10:15am - 12:15pm

Chairperson: Dr. Charles Eddy, NRL Co-chairperson: Dr. Karl Hobart, NRL Meeting Room: Colony Ballroom

10:15am - 10:45am FA5-01 Invited

Stress and Morphology Evolution during the Heteroepitaxial Growth of Group III-Nitrides Joan Redwing, Jeremy Acord, Ian Manning, Srinivasan Raghavan, Xiaojun Weng, Elizabeth C. Dickey, and D.W. Snyder, Penn State University

10:45am - 11:05am FA5-02

The Influence of Substrate Atomic Step Morphology on Threading Dislocation Distributions in III-Nitride Films Yoosuf N. Picard, Joshua D. Caldwell, Mark E. Twigg, Chip R. Eddy Jr., Michael A. Mastro, Richard L. Henry, and Ronald T. Holm, Naval Research Lab, Philip G. Neudeck, NASA Glenn Research Center, Andrew J. Trunek, OAI, and J. Anthony Powell, Sest Inc.

11:05am - 11:25am FA5-03

Etch Rates for Si-face 4H-SiC using H2 and a C3H8 Partial Pressure Brenda L. VanMil, Kok-Keong Lew, Rachael L. Myers-Ward, Ronald T. Holm, D. Kurt Gaskill, and Charles R. Eddy, Jr., US Naval Research Laboratory

11:25am - 11:45am FA5-04

H2 Etching and Epitaxial Growth on 4H-SiC Boule Domes Rachael L. Myers-Ward, Kok-Keong Lew, Brenda L. VanMil, Charles R. Eddy, and D. Kurt Gaskill, Naval Research Laboratory, and Colin E. Wood, Office of Naval Research

11:45am - 12:05pm FA5-05 Student

Triangular Shaped Defects Limiting Reverse Blocking Performance of 4H Silicon Carbide High Power Junction Barrier Schottky Devices Ronen Berechman and Marek Skowronski, Carnegie Mellon University, and Qingchun Zhang, CREE, Inc.

FA6: High Freqency II - 10:15am - 12:15pm

Chairperson: Dr. Dwight Woolard, ARO Meeting Room: Benjamin Banneker Room

10:15am - 10:45am FA6-01 Invited

Milliwatt THz Ouptut Power from a Photoconductive Switch Elliott R. Brown, Physical Domains, LLC

10:45am - 11:15am FA6-02 Invited

Plasma Waves in Graphene-Based Heterostructures and their Terahertz Device Applications Victor Ryzhii, Akira Satou, Maxim Ryzhii, and Fedir Vasko, University of Aizu, and Taiichi Otsuji, Tohoku University

11:15am - 11:35am FA6-03 Student

80nm In0.52Al0.48As/In0.53Ga0.47As/InAs0.3P0.7 Composite Channel HEMT with an fT of 280GHz Wu Lu, Dongmin Liu, Mantu Hudait, Yong Lin, and Steven A. Ringel, The Ohio State University

11:35am - 11:55am FA6-04

Impact of Lateral Engineering on the Logic Performance of Sub-50 nm InGaAs HEMTs Dae-Hyun Kim and Jesus A. del Alamoa, MIT

FA7:	Novel I	Nano	oscale	Dev	ices	and	Device	Technologies -	10:15am -	· 12:15pm

Chairperson: Dr. Glenn Jernigan, NRL

Meeting Room: Juan Jimenez Room

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10:15am - 10:45am	FA7-01 Gallium Nitride Nanowire Devices - Fabrication, Characterization, and Transport Properties Abhishek Motayed and A. V. Davydov, NIST, and S. N. Mohammad and J. Melngailis, University of Maryland				
10:45am - 11:15am	FA7-02 Student* Epitaxially Grown Graphene Field-Effect Transistors with Electron Mobility Exceeding 1500 cm2/Vs and Hole Mobility Exceeding 3400 cm2/Vs Yanqing Wu, Peide D. Ye, Michael A. Capano, Tian Shen, Yi Xuan, Yang Sui, Minghao Qi, and James A. Cooper Jr., Purdue University				
11:15am - 11:35am	FA7-03 Student Top-gated Field Effect Transistor using Thermally Oxidized Silicon Nanowires Synthesized by Vapor-liquid Solid Method Tsung-ta Ho, Yanfeng Wang, Bangzhi Liu, Sarah Eichfeld, Kok-Keong Lew, Suzanne Mohney, Joan Redwing, and Theresa Mayer, Pennsylvania State University				
11:35am - 11:55am	FA7-04 Student Transparent Organic Field-Effect Transistors with Carbon Nanotube Electrodes Adrian Southard, Vinod Kumar Sangwan, Ellen D. Williams, and Michael S. Fuhrer, University of Maryland				
11:55am - 12:15pm	FA7-05 Student Light Emitting Diodes on Glass and Silicon Substrates Fabricated Using Novel Low Temperature Hydrogenation-Assisted Nano-Crystallization of Silicon Thin Films Babak Fallah-Azad, Yaser Abdi, Shamsoddin Mohajerzadeh, Mehdi Jamei, and Pouya Hashemi, University of Tehran, and M. D. Robertson, Acadia University				
11:55am - 12:15pm	FA7-06 Student Fabrication and Characterization of Suspended Carbon Nanotubes Vinod Kumar Sangwan, Vincent W. Ballarotto, Michael S. Fuhrer, and Ellen D. Williams, University of Maryland				
FA8: Flexible I Chairperson: D	Electronics - 10:15am - 12:15pm r. Stephen Kilpatrick, ARL				
Meeting Room:	Charles Carroll Room				
10:15am - 10:45am	FA8-01 Invited Carbon Nanotubes for High Performance Flexible Electronics John A. Rogers, University of Illinois				
10:45am - 11:05am	FA8-02 Organic and Carbon-based Electronics Printed onto Flexible Substrates D. R. Hines, A. E. Southard, V. Sangwan, J-H. Chen, M. S. Fuhrer, and E. D. Williams, University of Maryland				
11:05am - 11:35am	FA8-03 Invited The US Display Consortium Program on Flexible, Printed, and Organic Electronics Mark Hartney, US Display Consortium				
11:35am - 11:55am	FA8-04 Student* Mechanically Strained Laser Crystallized Poly-Silicon Thin Film Transistors and Ring Oscillators Fabricated on Stainless Steel Abbas Jamshidi-Roudbari, Po-Chin Kuo, and Miltiadis Hatalis, Lehigh University				
11:55am - 12:15pm	FA8-05 Improvement of the Performance of Strained 0.13 um MOSFETs Mounted on Flexible Plastic Substrates Sean McAlister and .L. Kao, Chang Gung University, and C.C. Liao and Albert Chin, National Chiao-Tung University				
12:15pm - 1:15pm	Lunch (on your own)				

FP1: Photodetectors and Memory Devices - 1:15pm - 3:15pm Chairperson: Dr. Nibir Dhar, ARL Meeting Room: Colony Ballroom

Meeting Koom.	Colony Builloom
1:15pm - 1:35pm	FP1-01 Non-equilibrium Operation of Arsenic Diffused Long-wavelength Infrared HgCdTe Photodiodes Priyalal S. Wijewarnasuriya and Nibir K. Dhar, U.S. Army Research Laboratory
1:35pm - 1:55pm	FP1-02 Student A Type-II Near-Infrared Detector with Very High Stable Gain and Low Noise at Room Temperature Omer Gokalp Memis, Wei Wu, Dibyendu Dey, Alex Katsnelson, and Hooman Mohseni, Northwestern University
1:55pm - 2:15pm	FP1-03 Implementation and Study of Photovoltaic Cells Based on InP Lattice-Matched InGaAs and InGaAsP Mahieddine Emziane, Richard Tuley, and Robin J. Nicholas, University of Oxford, and Dave C. Rogers, Paul J. Cannard, and Jeevan Dosanjh, Centre for Integrated Photonics
2:15pm - 2:35pm	FP1-04 Student Characterization of Scaled MANOS Nonvolatile Semiconductor Gan Wang, Nathan Eichenlaub, Yanli Zhang, and Marvin H. White, Lehigh University
2:35pm - 2:55pm	FP1-05 Student Vertical AND (V-AND) Array: High Density, High Speed, and Reliable Flash Array Ilhan Park, Seongjae Cho, Jung Hun Lee, Gil Seong Lee, Doo-Hyun Kim, Jang-Gn Yoon, Yoon Kim, Sangwoo Kang, Daewoong Kang, Jong Duk Lee, and Byung-Gook Park, Seoul National University
2:55pm - 3:15pm	FP1-06 Ge/Si hetero-nanocrystal MOSFET memories Jianlin Liu and Bei Li, University of California, Riverside
FP2: Optoelect <i>Chairperson: L</i> <i>Meeting Room:</i>	ronic: New Detectors and Structures - 1:15pm - 3:15pm Dr. Christopher Davis, University of Maryland Benjamin Banneker Room

1:15pm - 1:35pm	FP2-01 Gate-Controlled Photodetector in PIN Technology for Distance Measurements Alexander Nemecek and Horst Zimmermann, Vienna University of Technolgoy
1:35pm - 1:55pm	FP2-02 Student A High Voltage PMOS Transistor for Quenching of Geiger-mode Avalanche Photodiodes in Deep Submicron CMOS Technologies Miriam Adlerstein Marwick and Andreas G. Andreou, Johns Hopkins University
1:55pm - 2:15pm	FP2-03 Student Properties of High-Performance Phototransistor Photodetector (PTPD) in Standard SiGe BiCMOS Technology Kuang-Sheng Lai, Ji-Cheng Huang, and Klaus YJ. Hsu, ROC
2:15pm - 2:35pm	FP2-04 Student Compact Demultiplexers with Narrow Spectral Width Channels Using Alternating-Defect Coupled-Cavity Waveguides (AD- CCWs) Faquir Jain and John Zeller, University of Connecticut
2:35pm - 2:55pm	FP2-05 Student Simulating Novel EM Effects Daniel P. Ceperley and Prof. Andrew Neureuther, U.C. Berkeley
2:55pm - 3:15pm	FP2-06 Student Particle-In-Cell Simulation of Resonant-Cavity-Enhanced Extraordinary Transmission through Sub-Wavelength Plasmonic Luke Johnson, Xi Shao, and Dennis Papadopoulos, University of Maryland

FP3: Advanced Characterization and Testing I - 1:15pm - 3:15pm Chairperson: Dr. David Storm, NRL Meeting Room: Juan Jimenez Room

1:15pm - 1:35pm	FP3-01 Determination of the Channel Temperature in GaN MOSHFETs under Microwave Operational Conditions Yanqing Deng, MD Monirul Islam, Mikhail Gaevski, Zijiang Yang, Vinod Adivarahan, and Asif Khan, University of South Carolina
1:35pm - 1:55pm	FP3-02 Student High-Speed Thermal Measurements of High-Power Diode Arrays Nicholas Rada, Gregory Triplett, and Samuel Graham, University of Missouri-Columbia, and Samuel Graham, Georgia Institute of Technology
1:55pm - 2:15pm	FP3-03 Student* Characterization of Latch-Up in CMOS Inverters in Pulsed Electromagnetic Interference Environments Kyechong Kim and Agis A. Iliadis, University of Maryland
2:15pm - 2:35pm	FP3-04 Room-Temperature Bias Acceleration Test for Data Retention Screening on SONOS Nonvolatile Memory Devices Jeong-Mo Hwang, Todd Wallinger, and Holden Hackbarth, Simtek Corporation
2:35pm - 2:55pm	FP3-05 Magnifying Superlens based on Plasmonic Metamaterials Igor Smolyaninov, Yu-Ju Hung, and Christopher C. Davis, University of Maryland
2:55pm - 3:15pm	FP3-06 Maximum Intrinsic Gain Degradation in Technology Scaling Mark Pude and P.R. Mukund, Rochester Institute of Technology, and Chris Macchietto, Prashant Singh, and Jeff Burleson, LSI Corporation
3:15pm - 3:30pm	Coffee Break - Grand Ballroom
ED4. Namel C	nuite and During 2.20mm 5.20mm
FP4: Novel Cl	rcuits and Devices - 5:50pm - 5:50pm
Chairperson: 1 Meeting Room:	<i>Colony Ballroom</i>
Chairperson: 1 Meeting Room: 3:30pm - 3:50pm	Freinis and Devices - 5:50pm Dr. Neil Goldsman, University of Maryland Colony Ballroom FP4-01 Bump-Technology Based Vertical Integration of Silicon Power Devices Alberto Castellazzi, Swiss Federal Institute of Technology Zurich (ETH Zurich), and Philippe Lasserre and Michel Mermet-Guyennet, ALSTOM - Power Electronics Associated Research Lab.
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FP5: Optoelectronic: New Lasers and Sources - 3:30pm - 5:30pm

Chairperson: Dr. Christopher Davis, University of Maryland

Meeting Room: Benjamin Banneker Room

3:30pm - 3:50pm	FP5-01 Student					
	Characterization of Complex-Coupled Multi-Quantum Well DFB Laser Diode with Embedded Absorptive Bragg Grating Jae-Ho Han, Johns Hopkins University, Zail Lhee, Samsung SDI, and Sung-Woong Park, Korea Intellectual Property Office					
3:50pm - 4:10pm	FP5-02					
	Y-coupled GaAs Quantum Cascade Lasers Gottfried Strasser, SUNY at Buffalo, and Leonard K. Hoffmann, Christophe A. Hurni, Elvis Mujagic, Michele Nobile, Aaron M. Andrews, Pavel Klang, and Werner Schrenk, TU Vienna					
4:10pm - 4:30pm	FP5-03					
	High-Temperature CW Mid-Infrared Interband Cascade Lasers Igor Vurgaftman, William W. Bewley, Chadwick L. Canedy, Chul Soo Kim, Mijin Kim, J. Ryan Lindle, D. C. Larrabee, J. A. Nolde and J. R. Meyer, Naval Research Laboratory					
4:30pm - 4:50pm	FP5-04 Student					
	Characteristic Temperature of a Tunneling-Injection Quantum Dot Laser Dae-Seob Han and Levon V. Asryan, Virginia Polytechnic Institute and State University					
4:50pm - 5:10pm	FP5-05 Student					
	Enhanced Nonlinear Susceptibility in Strained Quantum Cascade Lasers Denzil Roberts and Gregory Triplett, PhD, University of Missouri-Columbia					
5:10pm - 5:30pm	FP5-06 Student*					
	Minor Magnesium Doping in P-type Layer of InGaN/GaN MQW LED to Enhance Electrical and Optical Properties Ray-Ming Lin, Meng-Fu Shih, Yung-Hsiang Lin, Chun-Wei Liao, Cheng-Ying Yen, and Yi-Lun Chou, Chang Gung University					
FP6: Advance <i>Chairperson: I</i> <i>Meeting Room:</i>	ed Characterization and Testing II - 3:30pm - 5:30pm Dr. Martin Peckerar, University of Maryland Juan Jimenez Room					
3·30pm - 3·50pm	FP6-01					
	In Situ Gas Phase Infrared Absorption Measurements During Hafnium Oxide Atomic Layer Deposition James E. Maslar, W.S. Hurst, D.R. Burgess, W.A. Kimes, N.V. Nguyen, and E.F. Moore, NIST					
3:50pm - 4:10pm	FP6-02 The Semiconductor-Dielectric Interface from PN Junction Edge and the Voltage Dependence of Leakage Reverse Current Vasile Obreja, National R&D Institute for Microtechnology (IMT-Bucuresti)					
4:10pm - 4:30pm	FP6-03					
	PCA-based Network Modeling using Standardized X-ray Diffraction Data for the Electrical Characteristics of the HfO2 Thin Films Grown by MOMBE					
	Young-Don Ko, Pyung Moon, Chang Eun Kim, Moon-Ho Ham, Jae-Min Myoung, and Ilgu Yun, Yonsei University					

4:30pm - 4:50pm FP6-04 Student

Comprehensive Study on Dynamic Bias Temperature Instability of p-channel Polycrystalline Silicon Thin-film Transistors Ching-Fang Huang, Ying-Jhe Yang, Cheng-Yi Peng, Hung-Chang Sun, and Chee Wee Liu, National Taiwan University, and Chih-Wei Chao and Kun-Chih Lin, AU Optronics

4:50pm - 5:10pm FP6-05 Student

Characterization of the Low Temperature Activated P+/N Junction Formed by Implant Into Silicide Method Kow-Ming Chang, Jian-Hong Lin, and Chih-Hsiang Yang, National Chiao-Tung University

5:10pm - 5:30pm FP6-06 Student

Leakage Effect Suppression in Charge Pumping Measurement and Stress-Induced Traps in High-k Gated MOSFETs Kuei-Shu Chang-Liao, Chun-Chang Lu, Chun-Yuan Lu, Shih-Cheng Chang, and Tien-Ko Wang, National Tsing Hua University